

# PATENT ASSIGNMENT

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Zhi-Jiang Wu	12/17/2009
Xing-Fu Chen	12/17/2009
Yong-Ze Su	12/17/2009
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	AAC Acoustic Technologies (Shenzhen) Co., Ltd.
<b>Street Address:</b>	No.18 Xinxi Road, North Hi-Tech Industrial Park
<b>Internal Address:</b>	AAC Technologies Building
<b>City:</b>	Nanshan District, Shenzhen
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	518057
<b>Name:</b>	American Audio Components Inc.
<b>Street Address:</b>	1920 Wright Ave
<b>City:</b>	La Verne
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	91750
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12651457
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**REEL: 023725 FRAME: 0460**

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NAME OF SUBMITTER:

Jamie J. Zheng

Total Attachments: 2

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Attorney Docket No.: AAC -00008

ASSIGNMENT

THIS ASSIGNMENT is by Zhi-Jiang Wu a P.R.China citizen, with a mailing address of AAC Technologies Building, No.18 Xinx Road, North Hi-Tech Industrial Park, Nanshan District, Shenzhen, 518057, P.R.China, Xing-Fu Chen a P.R.China citizen, with a mailing address of AAC Technologies Building, No.18 Xinx Road, North Hi-Tech Industrial Park, Nanshan District, Shenzhen, 518057, P.R.China, Yong-Ze Su a P.R.China citizen, with a mailing address of AAC Technologies Building, No.18 Xinx Road, North Hi-Tech Industrial Park, Nanshan District, Shenzhen, 518057, P.R.China (the "ASSIGNORS"). We, the ASSIGNORS, have invented one or more certain inventions (the "IMPROVEMENTS") described in a United States Patent Application entitled MEMS MICROPHONE (the "APPLICATION") and ☒ executed concurrently herewith or ☐ filed as United States Patent Application Serial No. \_\_\_\_\_ on \_\_\_\_\_. We, the ASSIGNORS, hereby authorize and request the ASSIGNEES, identified below, or the attorney, **Jamie J. Zheng, CUSTOMER NUMBER 79141**, to insert in the header and body of this instrument, the filing date and application number of the Application when known.

WHEREAS, **AAC Acoustic Technologies (Shenzhen) Co., Ltd.**, a Corporation with its principal place of business at AAC Technologies Building, No.18 Xinx Road, North Hi-Tech Industrial Park, Nanshan District, Shenzhen, P.R.China, and **American Audio Components Inc.** a Corporation with its principal place of business at La Verne, CA, USA (the "ASSIGNEES"), desires to acquire the entire right, title, and interest in and to said IMPROVEMENTS and said Application:

NOW, THEREFORE, in light of good and valuable consideration, the receipt of which is hereby acknowledged, we, the said inventors, do hereby acknowledge that I have sold, assigned, transferred, and set over, and by these presents do hereby sell, assign, transfer, and set over, unto the said ASSIGNEES, its successors, legal representatives, and assigns, the entire right, title, and interest throughout the world in, to, and under the said IMPROVEMENTS, and the said APPLICATION, and any divisions, continuations, and continuations-in-part of the APPLICATION, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which have been and which may hereafter be filed for said IMPROVEMENTS in any country or countries foreign to the United States, and all Letters Patent which may be granted for said IMPROVEMENTS in any country or countries foreign to the United States and all extensions, renewals, and reissues thereof (collectively, the "RIGHTS"); and we hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said IMPROVEMENTS to the said ASSIGNEES, its successors, legal representatives, and assigns, in accordance with the terms of this instrument.

AND WE DO HEREBY sell, assign, transfer, and convey to ASSIGNEES, its successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the RIGHTS assigned hereby that may have accrued prior to the date of assignment to ASSIGNEES, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of said Letters Patent before or after issuance.

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AND WE HEREBY covenant and agree that we will communicate to said ASSIGNEES, its successors, legal representatives, and assigns, any facts known to us respecting said IMPROVEMENTS, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths, and generally do everything possible to aid said ASSIGNEES, its successors, legal representatives, and assigns, to obtain and enforce proper patent protection for said IMPROVEMENTS in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 17 day of Dec., 2009

Zhi-jiang Wu  
Zhi-Jiang Wu

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 17 day of Dec., 2009

Xing-Fu Chen  
Xing-Fu Chen

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 17 day of December, 2009

Yong-Ze Su  
Yong-Ze Su

WITNESS my hand

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 17 day of December, 2009

Wei Yong  
Wei Yong

Address: AAC Technologies Building, No.18 Xinxi Road,  
North Hi-Tech Industrial Park, Nanshan District,  
Shenzhen, P.R.China

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 17 day of December, 2009

Guo-Ying Hu  
Guo-Ying Hu

Address: AAC Technologies Building, No.18 Xinxi Road,  
North Hi-Tech Industrial Park, Nanshan District,  
Shenzhen, 518057, P.R.China

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